ASOCIATION CONNECTING ELECTRONICS INDUSTRIES® INTERNATION CONNECTING	ourn. Illinois. All rights reserved u	under both This do	cument is a declaration e	on of the substance ncompasses all low	es within the manufactur wer level materials for wl	er listed item. Note: hich the manufacture	if the item is an a r has engineering	ssembly with lower responsibility.		
1752-21.1 IPC Web Site for Information on I http://www.ipc.org/IPC-175x	PC-1752 Standard	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information				ion			
Supplier Information										
Company name*	y name* Company unique ID			Unique ID Authority			Response Date*			
onsemi						2025-06-08				
Contact Name	Title - Contact		Phone - Conta	Phone - Contact*			Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	Title - Representative		Phone - Repres	Phone - Representative*			Email - Representative*			
Product-Env-Stewards Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Item	Number Mfr Item Name	· · · ·		Version	Manufacturing Site	Weight*	UOM	Unit Type		
ADM10 REEL	23ARQZ- THERMAL DIO	DE MONITOR IC	2025-06-08 PH1		PH1	77.0	mg	Each		
Manufacturing Proccess Information										
Terminal Plating / Grid Array Material	Ferminal Base Alloy	J-STD-020 MSL Rating	Peak Proc	ess Body Tempera	ture Max Time at Peak	Temperature Num	ber of Reflow Cy	cles		
Matte Tin (Sn) - annealed	Matte Tin (Sn) - annealed CU Alloy		260	С	30	seconds 3	-			
Comments			i.	·						
evel 1 - maximum time at peak temperature during so	Idering is 10-30 seconds									
For more information regarding material composition	0									

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.3	mg	Supplier	Silicon (Si)	7440-21-3		1.3	mg
Die Attach 0.3	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.2325	mg
			Supplier	Epoxy resins	129915-35-1		0.0775	mg
Lead Frame 3	31.11	mg	Supplier	Silver (Ag)	7440-22-4		0.4449	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0373	mg
			Supplier	Iron (Fe)	7439-89-6		0.7218	mg
			Supplier	Copper (Cu)	7440-50-8		29.8967	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0093	mg
Mold Compound-Black	43.0	mg		Epoxy Phenol Resin	proprietary data		4.515	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.485	mg
Plating	0.86	mg	Supplier	Tin (Sn)	7440-31-5		0.86	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg